

Docket No. JCLA6319

Form 1595 RECORDATION FORM COVER S	HEET U.S. Department of Commerce Patent and Trademark Office
PATENTS ONLY	9-5-00
To the Honorable Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.	
Name of conveying party(ies): Shih-Kuang Chiu; Ying Chou Tsai; Chao-Dung Suo; Kuo-Liang Mao	2. Name/address of receiving Party(ies): Siliconware Precision Industries Co., Ltd.
3. Nature of conveyance: ☒ Assignment ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment	No. 123, Ta-Fong Rd., Tan-Tzu Hsiang, Taichung Hsien, Taiwan, R.O.C.
4. Date(s) of execution: August 16, 2000	Add`l names of receiving parties Attached? Yes No
5. Application number(s) or patent number(s): 99/654.813	
If this documents is being filed together with a new application, the execution date of the application is August 16, 2000.	
A. Patent Application No. (s)	B. Patent No. (s)
Additional numbers attached 6. Name and address of party to whom correspondence concerning document should be mailed: J.C. Patents, Inc. 1340 Reynolds Ave., Suite 114 Irvine, CA 92614 (949) 660-0761	 ? ☐ Yes ☒ No 7. Total No. of applications and patents involved: ONE(1) 8. Total fee (37 CFR §3.41): \$40.00 ☒ Enclosed ☐ Charge to Acct. No. 9. Total number of pages, including cover sheet, attachments and document 3.
DO NOT USE THIS SPACE	
10. Statement and Signature:	
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
Jiawei Huang Name of Person Signing Signature 9/5/00 Date	

Registration No. 43, 330

09/22/2000 MTHAI1 00000331 09654812

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PATENT REEL: 011090 FRAME: 0145

ASSIGNMENT

WHEREAS,

1. Shih-Kuang Chiu

3. Chao-Dung Suo

2. Ying Chou Tsai

4. Kuo-Liang Mao

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: BUMP STRUCTURE WITH DOPANTS

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Siliconware Precision Industries Co., Ltd.

of No. 123, Ta-Fong Rd., Tan-Tzu Hsiang, Taichung Hsien, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Shih Kuang Chill

Signature:

Sole or First Joint Inventor: Shih-Kuang Chiu

Date: 16, 2000

Signature: Ting Chou Tsai

Second Joint Inventor (if any): Ying Chou Tsai

Chao-Dung Suo

Signature:

Third Joint Inventor (if any): Chao-Dung Suo

Third John Mentor (II any). Chao-Dung Suc

Signature: Liang Mac Signature: Mac Liang Mac

RECORDED: 09/05/2000

Date:

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